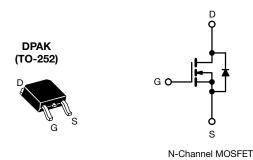
Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY				
V_{DS} (V) at T _J max.	850			
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.82		
Q _g max. (nC)	44			
Q _{gs} (nC)	5			
Q _{gd} (nC)	8			
Configuration	Single			

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
- Welding
- Induction heating
- Motor drives
- Battery chargers
- Renewable energy
- Solar (PV inverters)

ORDERING INFORMATION			
Package	DPAK (TO-252)		
Lead (Pb)-free and halogen-free	SiHD6N80E-GE3		

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	800	- V
Gate-source voltage			V _{GS}	± 30	v
Continuous drain current (T _J = 150 °C)	V at 10 V	T _C = 25 °C T _C = 100 °C	- I _D	5.4	
	V _{GS} at 10 V	T _C = 100 °C		3.4	А
Pulsed drain current ^a			I _{DM}	15	
Linear derating factor				0.63	W/°C
Single pulse avalanche energy ^b			E _{AS}	95	mJ
Maximum power dissipation			P _D	78	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope	T _J = 125 °C		du /dt	70	1//20
Reverse diode dv/dt ^d			dv/dt	0.25	V/ns
Soldering recommendations (peak temperature) ^c	nperature) ^c For 10 s			300	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 2.6 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, di/dt = 100 A/µs, starting T_J = 25 °C

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SHA

SiHD6N80E

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PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	- 62 - 1.6						
Maximum junction-to-case (drain)	R _{thJC}				°C/W			
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, u	Inless otherw	ise noted)						
PARAMETER	SYMBOL	TES	T CONDITIO	ONS	MIN.	TYP.	MAX.	UNI
Static						•		
Drain-source breakdown voltage	V _{DS}	V _{GS} =	V _{GS} = 0 V, I _D = 250 μA		800	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I	_D = 1 mA	-	1.1	-	V/°0
Gate-source threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	50 µA	2.0	-	4.0	V
	1		V _{GS} = ± 20 V	/	-	-	± 100	nA
Gate-source leakage	I _{GSS}		V _{GS} = ± 30 V	/	-	-	± 1	μA
Zara gata valtaga drain aurrant	I	V _{DS} =	= 800 V, V _{GS}	= 0 V	-	-	1	
Zero gate voltage drain current	IDSS	V _{DS} = 640 V	$V_{DS} = 640 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$		-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	ار	₀ = 3 A	-	0.82	0.94	Ω
Forward transconductance	9 _{fs}	V _{DS}	= 30 V, I _D =	= 3 A	-	2.5	-	S
Dynamic								
Input capacitance	C _{iss}		V _{GS} = 0 V,		-	827	-	
Output capacitance	C _{oss}	$V_{DS} = 100 V,$		-	37	-		
Reverse transfer capacitance	C _{rss}		f = 1 MHz		-	5	-	_
Effective output capacitance, energy related ^a	C _{o(er)}	V_{DS} = 0 V to 480 V, V_{GS} = 0 V		-	24	-	pF	
Effective output capacitance, time related ^b	C _{o(tr)}			-	109	-		
Total gate charge	Qg	$V_{GS} = 10 \text{ V}$ $I_D = 3 \text{ A}, V_{DS} = 480 \text{ V}$		-	22	44	nC	
Gate-source charge	Q _{gs}			-	5	-		
Gate-drain charge	Q _{gd}				-	8	-	1
Turn-on delay time	t _{d(on)}				-	13	26	
Rise time	t _r	Vpp	= 480 V, I _D =	- 3 A	-	9	18	
Turn-off delay time	t _{d(off)}		= 10 V, R _g =		-	27	54	ns
Fall time	t _f]		-	18	36		
Gate input resistance	R _g	f = 1 MHz, open drain		0.5	1.0	2.0	Ω	
Drain-Source Body Diode Characteristi	cs							
Continuous source-drain diode current	I _S	MOSFET sym showing the	MOSFET symbol showing the		-	-	5.4	
Pulsed diode forward current	I _{SM}	integral reverse p - n junction diode		-	-	15	A	
Diode forward voltage	V _{SD}	$T_{J} = 25 \text{ °C}, I_{S} = 3 \text{ A}, V_{GS} = 0 \text{ V}$		-	-	1.2	V	
Reverse recovery time	t _{rr}		, , ,		-	282	564	ns
Reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 3 \text{ A},$ di/dt = 100 A/µs, $V_R = 25 \text{ V}$		-	2.0	4.0	μΟ	
Reverse recovery current	I _{RRM}			-	11		A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 V to 480 V V_{DSS}

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 V to 480 V VDSS



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

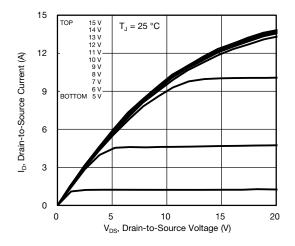
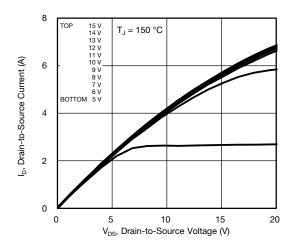


Fig. 1 - Typical Output Characteristics





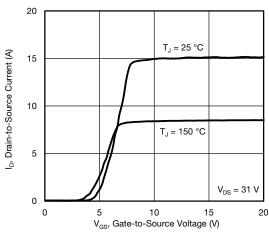


Fig. 3 - Typical Transfer Characteristics

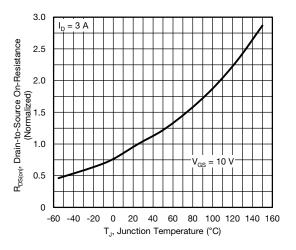


Fig. 4 - Normalized On-Resistance vs. Temperature

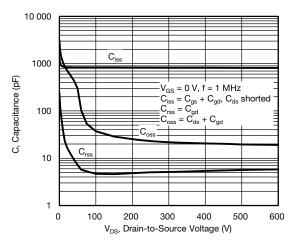


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

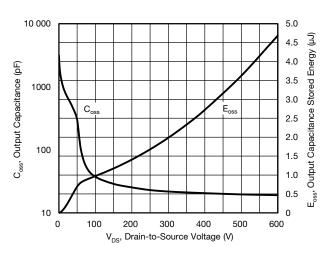


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

3 nical questions, contact: hym@yisl Document Number: 92010



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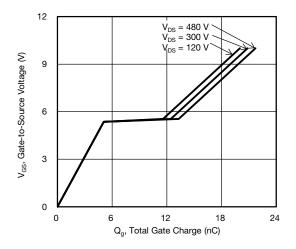


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

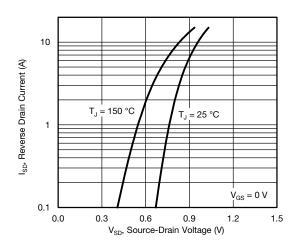


Fig. 8 - Typical Source-Drain Diode Forward Voltage

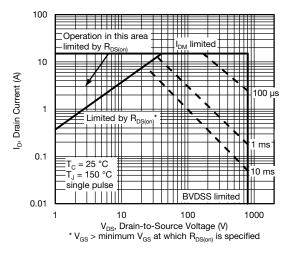


Fig. 9 - Maximum Safe Operating Area

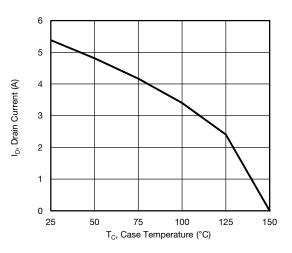


Fig. 10 - Maximum Drain Current vs. Case Temperature

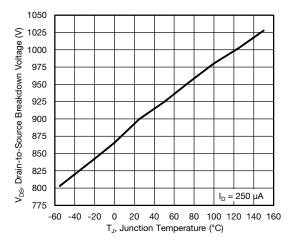


Fig. 11 - Temperature vs. Drain-to-Source Voltage



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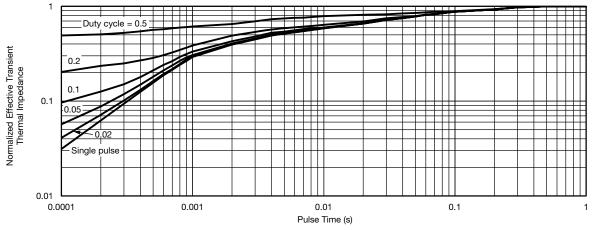


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

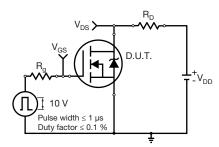


Fig. 13 - Switching Time Test Circuit

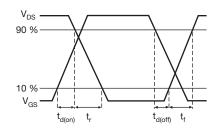


Fig. 14 - Switching Time Waveforms

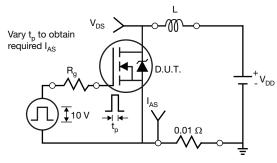


Fig. 15 - Unclamped Inductive Test Circuit

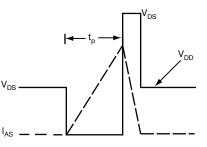


Fig. 16 - Unclamped Inductive Waveforms

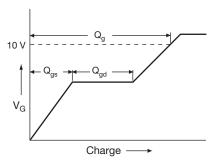


Fig. 17 - Basic Gate Charge Waveform

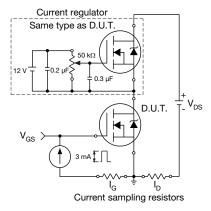


Fig. 18 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit

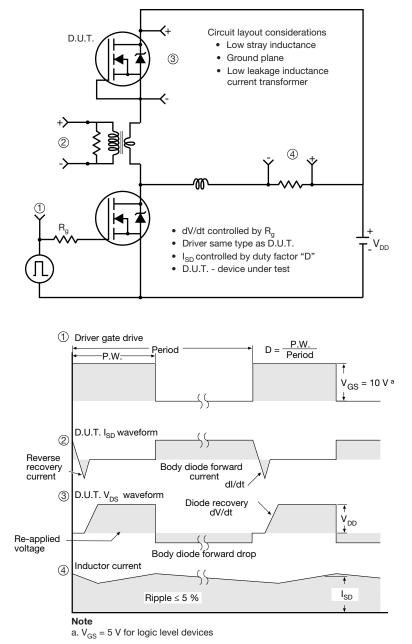


Fig. 19 - For N-Channel

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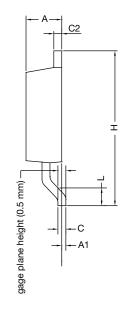


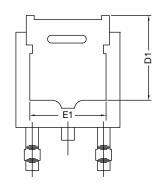


TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







	MILLIMETERS			
DIM.	MIN.	MAX.		
А	2.18	2.38		
A1	-	0.127		
b	0.64	0.88		
b2	0.76	1.14		
b3	4.95	5.46		
С	0.46	0.61		
C2	0.46	0.89		
D	5.97	6.22		
D1	4.10	-		
E	6.35	6.73		
E1	4.32	-		
Н	9.40	10.41		
е	2.28	2.28 BSC		
e1	4.56	4.56 BSC		
L	1.40	1.78		
L3	0.89	1.27		
L4	-	1.02		
L5	1.01	1.52		

Note

• Dimension L3 is for reference only



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VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
А	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	-	
E	6.35	6.73	
E1	4.32 -		
е	2.29 BSC		
Н	9.94	10.34	

	MILLIMETERS			
DIM.	MIN.	MAX.		
L	1.50	1.78		
L1	2.74	2.74 ref.		
L2	0.51 BSC			
L3	0.89	1.27		
L4	-	1.02		
L5	1.14	1.49		
L6	0.65	0.85		
θ	0°	10°		
θ1	0°	15°		
θ2	25°	35°		

Notes

• Dimensioning and tolerance confirm to ASME Y14.5M-1994

• All dimensions are in millimeters. Angles are in degrees

• Heat sink side flash is max. 0.8 mm

Radius on terminal is optional

ECN: E22-0399-Rev. R, 03-Oct-2022 DWG: 5347

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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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